

Features

- $BV_{CEO} > 20V$
- $I_C = 2A$ Collector Current
- Low Saturation Voltage $V_{CE(sat)} < 70mV @ 1A$
- Epitaxial Planar Die Construction
- High Peak Current and Gain
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact@diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

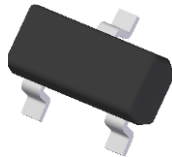
Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.008 grams (Approximate)

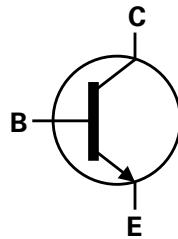
Applications

- DC-DC converters
- DC fans
- Power switches
- Motor controls
- MOSFET gate drivers

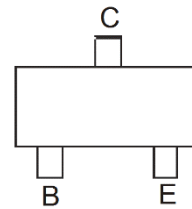
SOT23



Top View



Device Symbol

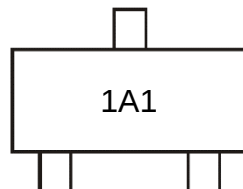

 Top View
Pinout

Ordering Information (Note 4)

Orderable Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
ZXTN25020DFLTA	SOT23	1A1	7	8	3,000	Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



1A1 = Product Type Marking Code

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	100	V
Collector-Emitter Voltage	V _{CEO}	20	V
Emitter-Base Voltage	V _{EBO}	7	V
Collector-Emitter Voltage (Forward Blocking)	V _{CEX}	150	V
Emitter-Collector Voltage (Reverse Blocking)	V _{ECO}	5	V
Base Current	I _B	0.5	A
Continuous Collector Current	I _C	2	A
Peak Collector Current	I _{CM}	8	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation	P _D	350	mW
Linear Derating Factor		2.8	mW/°C
Thermal Resistance, Junction to Ambient	R _{θJA}	357	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Note: 5. For the device mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

Thermal Characteristics

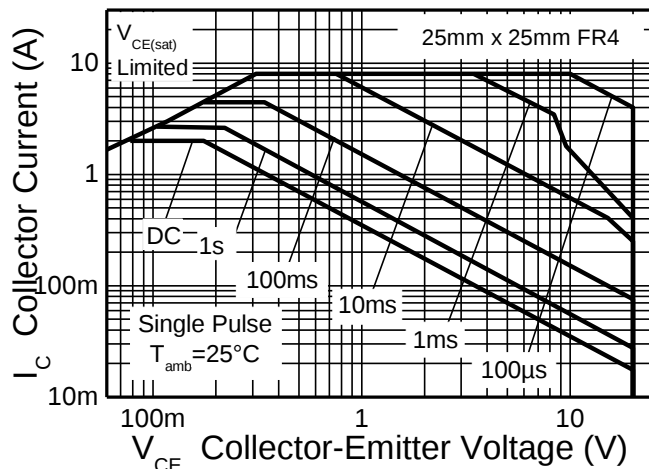


Figure 1. Safe Operating Area

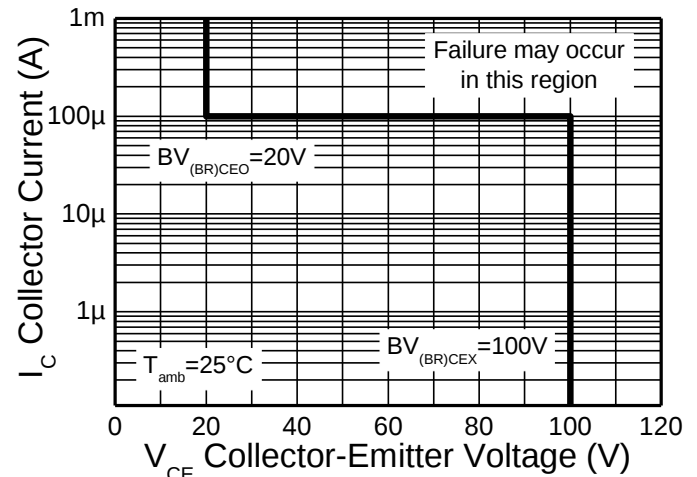


Figure 2. Safe Operating Area

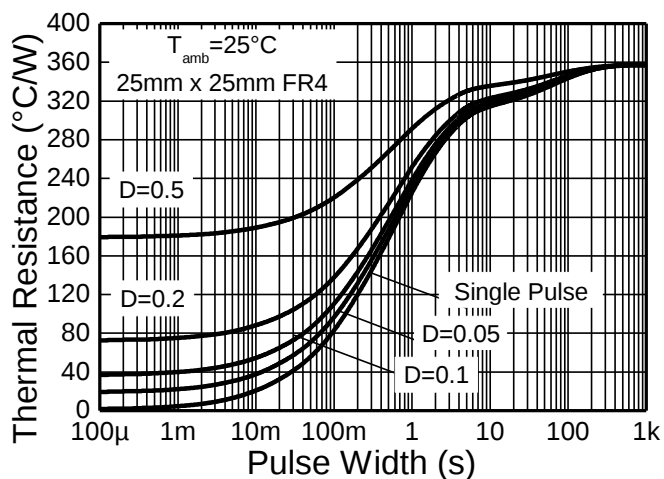


Figure 3. Transient Thermal Impedance

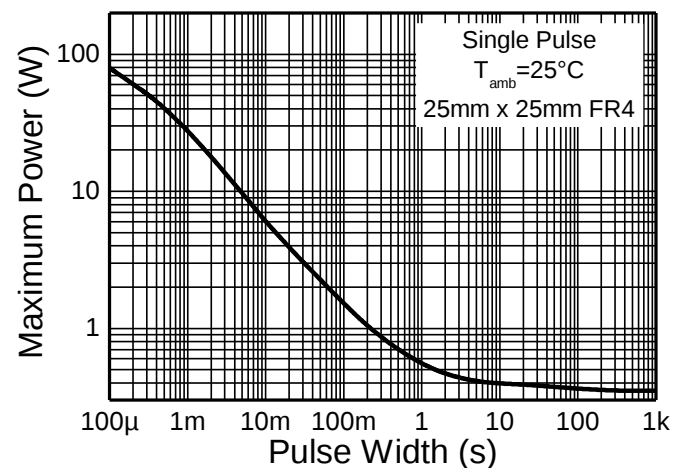


Figure 4. Pulse Power Dissipation

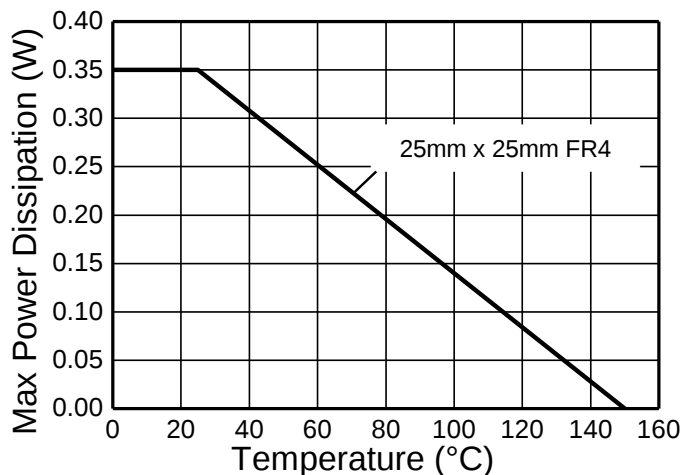


Figure 5. Derating Curve

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	100	125	—	V	I _C = 100μA
Collector-Emitter Breakdown Voltage (Note 6)	BV _{CEO}	20	35	—	V	I _C = 10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.3	—	V	I _E = 100μA
Emitter-Collector Breakdown Voltage	BV _{ECO}	5	6	—	V	I _E = 100μA
Emitter-Collector Breakdown Voltage	BV _{ECX}	6	8	—	V	I _E = 100μA, R _{BC} ≤ 1kΩ or -0.25V < V _{BC} < 0.25V
Collector-Emitter Breakdown Voltage	BV _{CEX}	100	120	—	V	I _C = 100μA, R _{BE} ≤ 1kΩ or -1V < V _{BE} < 0.25V
Collector Cutoff Current	I _{CBO}	—	1	50	nA	V _{CB} = 80V
		—	—	20	μA	V _{CB} = 80V, T _{amb} = +100°C
Emitter Cutoff Current	I _{EBO}	—	1	50	nA	V _{EB} = 5.6V
Collector-Emitter Cutoff Current	I _{CEX}	—	—	100	nA	V _{CE} = 80V, R _{BE} ≤ 1kΩ or -1V < V _{BE} < 0.25V
ON CHARACTERISTICS (Note 6)						
DC Current Gain	h _{FE}	300	450	900	—	I _C = 10mA, V _{CE} = 2V
		220	350	—		I _C = 2A, V _{CE} = 2V
		80	120	—		I _C = 4.5A, V _{CE} = 2V
Collector-Emitter Saturation Voltage	V _{CE(sat)}	—	60	70	mV	I _C = 1A, I _B = 100mA
		—	85	100		I _C = 1A, I _B = 20mA
		—	140	160		I _C = 2A, I _B = 40mA
		—	180	225		I _C = 2A, I _B = 20mA
		—	245	270		I _C = 4.5A, I _B = 450mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	—	895	1000	mV	I _C = 2A, I _B = 40mA
Base-Emitter Turn-On Voltage	V _{BE(on)}	—	825	900	mV	I _C = 2A, V _{CE} = 2V
SMALL-SIGNAL CHARACTERISTICS						
Output Capacitance (Note 6)	C _{obo}	—	16.5	25	pF	V _{CB} = 10V, f = 1MHz
Transition Frequency	f _T	—	215	—	MHz	V _{CE} = 10V, I _C = 50mA f = 100MHz
SWITCHING CHARACTERISTICS						
Delay Time	t _d	—	67.7	—	ns	V _{CC} = 10V, I _C = 1A I _{B1} = -I _{B2} = 10mA
Rise Time	t _r	—	72.2	—	ns	
Storage Time	t _s	—	361	—	ns	
Fall Time	t _f	—	63.9	—	ns	

Note: 6. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

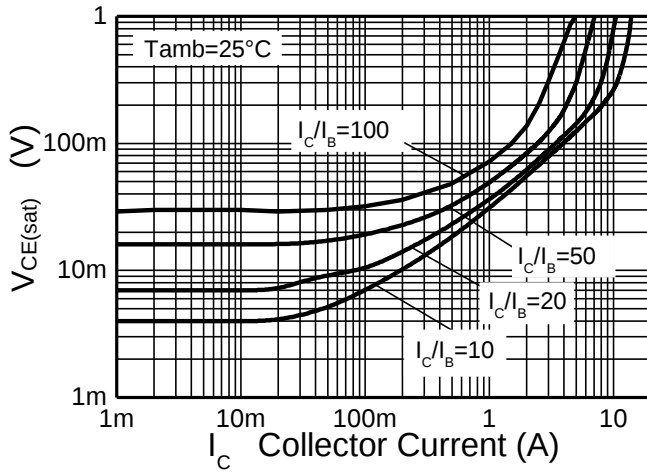


Figure 6. $V_{CE(sat)}$ vs. I_C

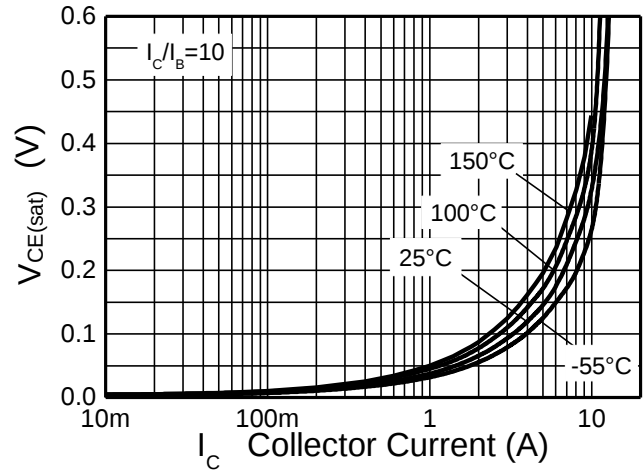


Figure 7. $V_{CE(sat)}$ vs. I_C

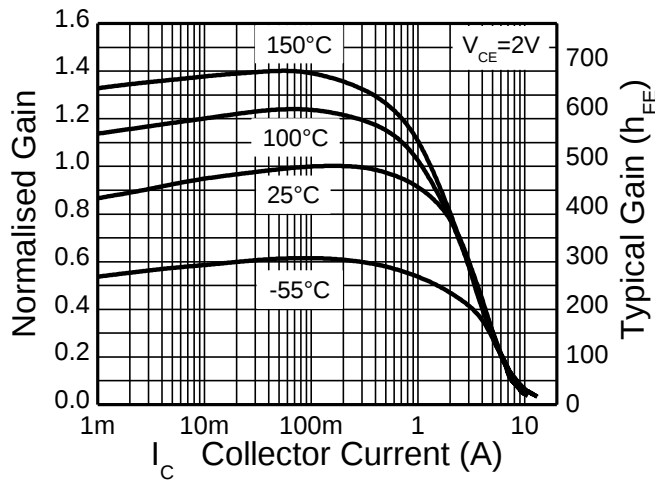


Figure 8. h_{FE} vs. I_C

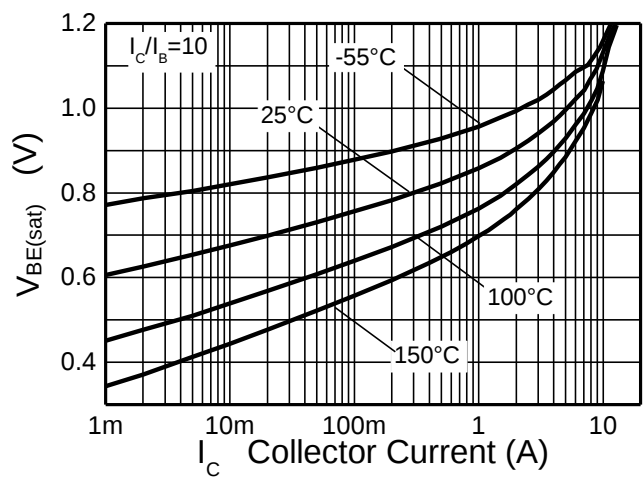


Figure 9. $V_{BE(sat)}$ vs. I_C

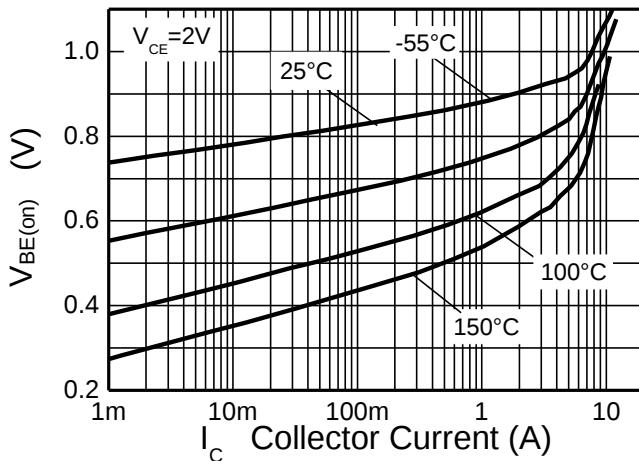
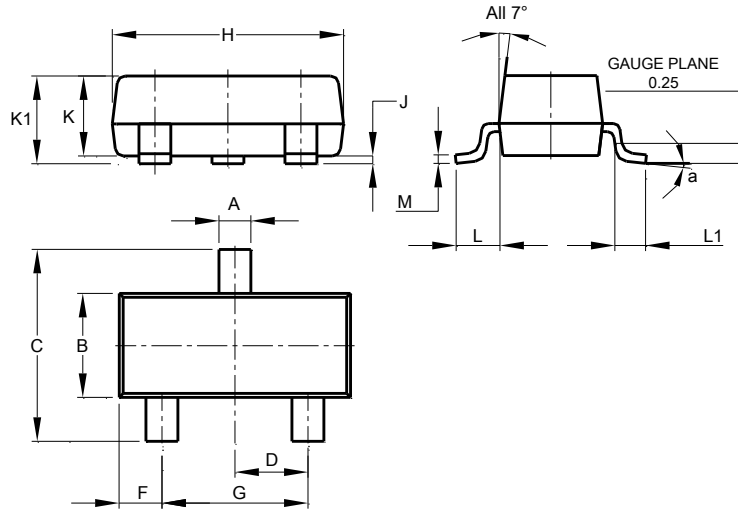


Figure 10. $V_{BE(on)}$ vs. I_C

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23

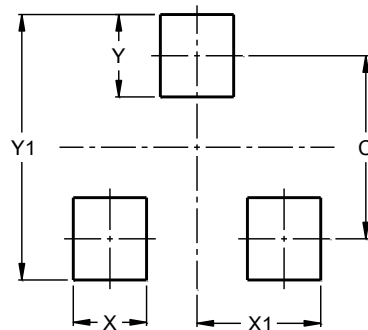


SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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